

Dual P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | |
|---------------------|------------------------------------|------------------------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^{d, e} | Q _g (Typ.) |
| - 30 | 0.021 at V _{GS} = - 10 V | - 8.0 | 15 nC |
| | 0.028 at V _{GS} = - 4.5 V | - 7.0 | |

FEATURES

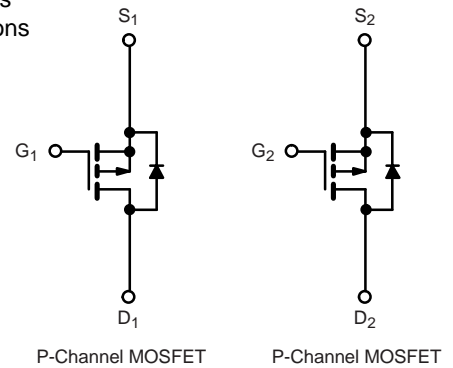
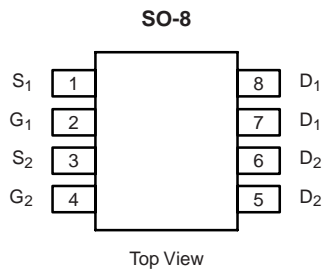
- Halogen-free
- TrenchFET® Power MOSFET
- 100 % UIS Tested



RoHS
COMPLIANT

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs
 - Game Stations



| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | |
|---|-----------------------------------|------------------------|-----------------------|
| Parameter | Symbol | Limit | Unit |
| Drain-Source Voltage | V _{DS} | - 30 | V |
| Gate-Source Voltage | V _{GS} | ± 20 | |
| Continuous Drain Current (T _J = 150 °C) | I _D | T _C = 25 °C | - 9.5 ^e |
| | | T _C = 70 °C | - 8.0 ^e |
| | | T _A = 25 °C | - 8.3 ^{a, b} |
| | | T _A = 70 °C | - 7.9 ^{a, b} |
| Pulsed Drain Current | I _{DM} | - 32 ^e | A |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | |
| | | T _A = 25 °C | - 2.0 ^{a, b} |
| Avalanche Current | I _{AS} | - 20 | mJ |
| Single-Pulse Avalanche Energy | E _{AS} | 20 | |
| Maximum Power Dissipation | P _D | T _C = 25 °C | 5.0 |
| | | T _C = 70 °C | 3.2 |
| | | T _A = 25 °C | 2.5 ^{a, b} |
| | | T _A = 70 °C | 1.6 ^{a, b} |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|-------------------|---------|---------|------|--|
| Parameter | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | R _{thJA} | 38 | 50 | °C/W | |
| Maximum Junction-to-Foot | R _{thJF} | 20 | 25 | | |

Notes:

- Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under Steady State conditions is 85 °C/W.
- Based on T_C = 25 °C.
- Limited by package.

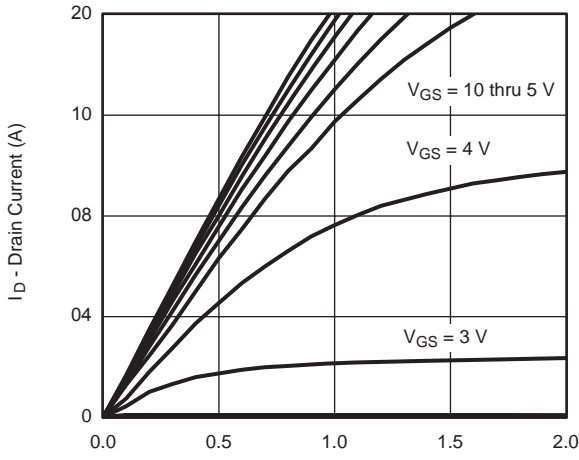
| SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted | | | | | | |
|---|-------------------------|--|--------------------|--------|-----------|----------------------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$ | - 30 | | | V |
| V_{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | $I_D = -250\text{ }\mu\text{A}$ | | - 31 | | mV/ $^\circ\text{C}$ |
| $V_{GS(th)}$ Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | 4.5 | | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$ | - 1.0 | | - 3.0 | V |
| Gate-Source Leakage | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$ | | | - 1 | μA |
| | | $V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$ | | | - 5 | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \geq -10\text{ V}, V_{GS} = -10\text{ V}$ | - 30 | | | A |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = -10\text{ V}, I_D = -7.3\text{ A}$ | | 0.021 | | Ω |
| | | $V_{GS} = -4.5\text{ V}, I_D = -6.2\text{ A}$ | | 0.028 | | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = -10\text{ V}, I_D = -9.1\text{ A}$ | | 23 | | S |
| Dynamic^b | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = -15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | | 1350 | | pF |
| Output Capacitance | C_{oss} | | 215 | | | |
| Reverse Transfer Capacitance | C_{rss} | | 185 | | | |
| Total Gate Charge | Q_g | $V_{DS} = -15\text{ V}, V_{GS} = -10\text{ V}, I_D = -9.1\text{ A}$ | | 32 | 50 | nC |
| | | | | 15 | 25 | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = -15\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -9.1\text{ A}$ | | 4 | | nC |
| Gate-Drain Charge | Q_{gd} | | 7.5 | | | |
| Gate Resistance | R_g | | $f = 1\text{ MHz}$ | | 5.8 | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = -15\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong -1\text{ A}, V_{GEN} = -10\text{ V}, R_g = 1\text{ }\Omega$ | | 10 | 15 | ns |
| Rise Time | t_r | | 8 | 15 | | |
| Turn-Off DelayTime | $t_{d(off)}$ | | 45 | 70 | | |
| Fall Time | t_f | | 12 | 25 | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = -15\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 1\text{ }\Omega$ | | 42 | 70 | |
| Rise Time | t_r | | 35 | 60 | | |
| Turn-Off DelayTime | $t_{d(off)}$ | | 40 | 70 | | |
| Fall Time | t_f | | 16 | 30 | | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continous Source-Drain Diode Current | I_S | $T_C = 25\text{ }^\circ\text{C}$ | | | - 4.1 | A |
| Pulse Diode Forward Current | I_{SM} | | | | - 32 | |
| Body Diode Voltage | V_{SD} | $I_S = -2\text{ A}, V_{GS} = 0\text{ V}$ | | - 0.75 | - 1.2 | V |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = -2\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$ | | 34 | 60 | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | | 22 | 40 | nC | |
| Reverse Recovery Fall Time | t_a | | 11 | | ns | |
| Reverse Recovery Rise Time | t_b | | 23 | | | |

Notes:

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

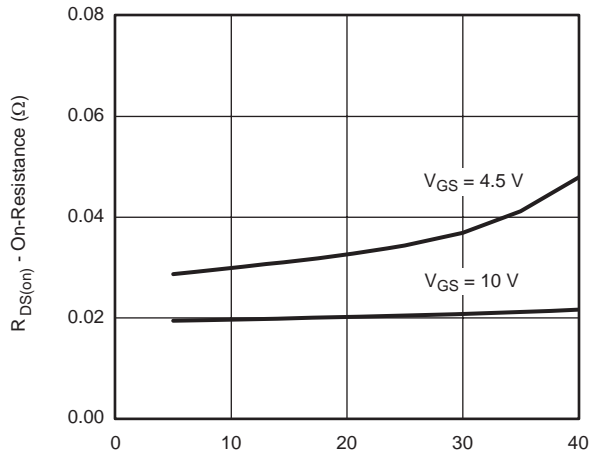
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V_{DS} - Drain-to-Source Voltage (V)
Output Characteristics



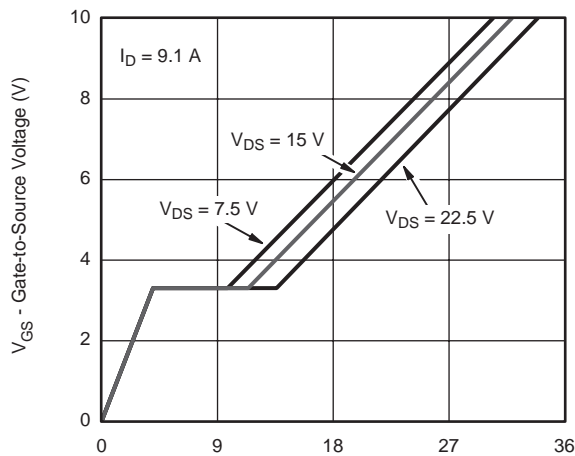
V_{GS} - Gate-to-Source Voltage (V)
Transfer Characteristics



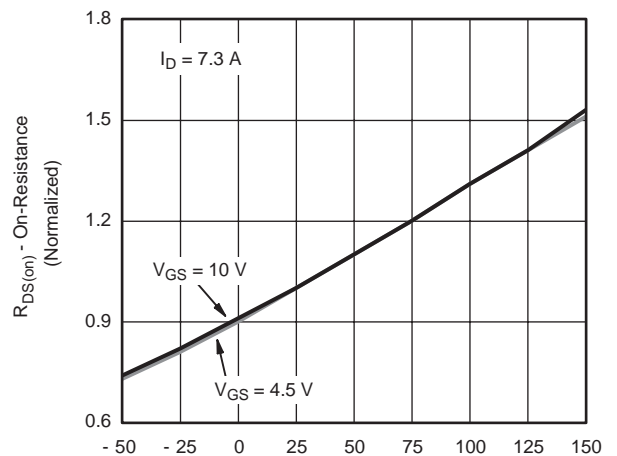
I_D - Drain Current (A)
On-Resistance vs. Drain Current



V_{DS} - Drain-to-Source Voltage (V)
Capacitance

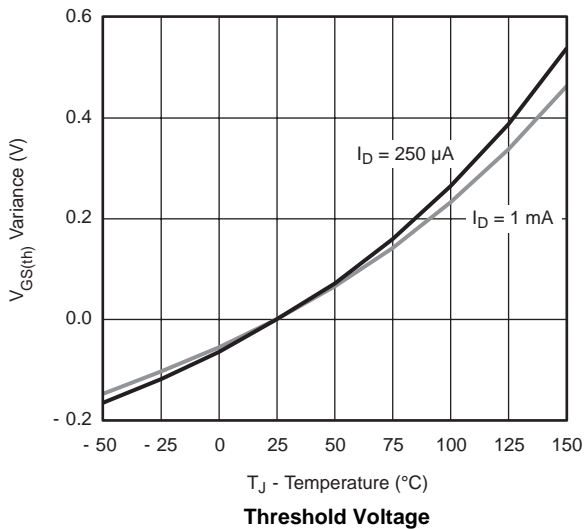
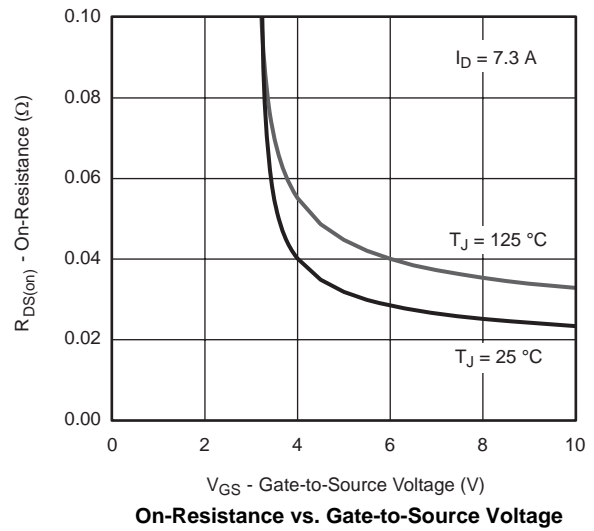
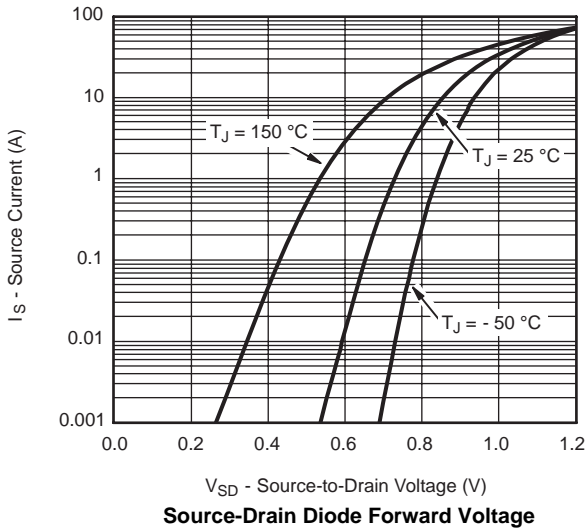


Q_g - Total Gate Charge (nC)
Gate Charge



T_J - Junction Temperature ($^\circ\text{C}$)
On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



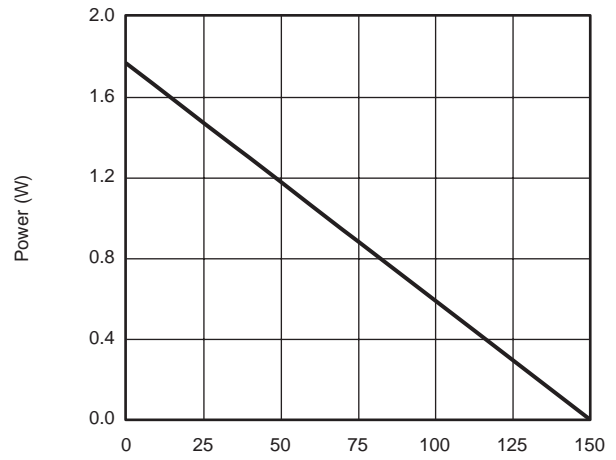
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*



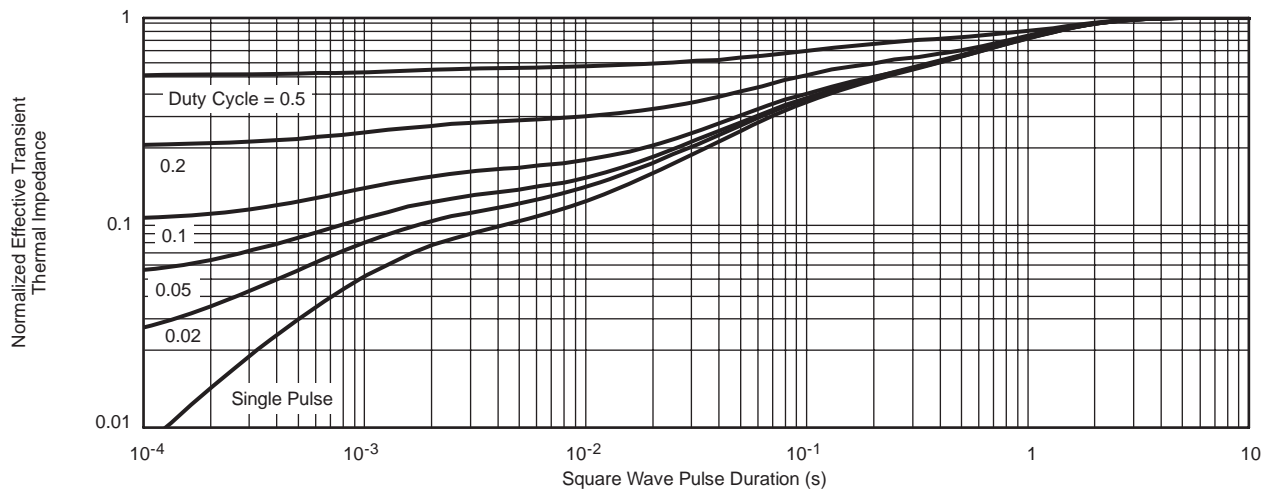
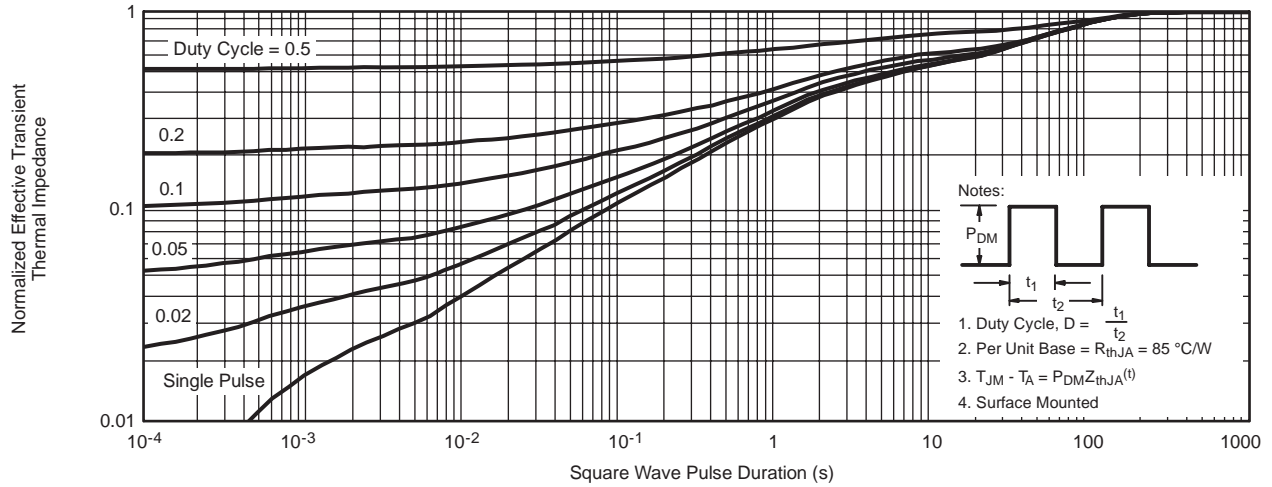
Power, Junction-to-Foot



Power Derating, Junction-to-Ambient

* The power dissipation P_D is based on $T_{J(max)} = 150\text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



| DIM | MILLIMETERS | | INCHES | |
|--------------------------------|-------------|------|-----------|-------|
| | Min | Max | Min | Max |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 |
| B | 0.35 | 0.51 | 0.014 | 0.020 |
| C | 0.19 | 0.25 | 0.0075 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.196 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC | | 0.050 BSC | |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.020 |
| L | 0.50 | 0.93 | 0.020 | 0.037 |
| q | 0° | 8° | 0° | 8° |
| S | 0.44 | 0.64 | 0.018 | 0.026 |
| ECN: C-06527-Rev. I, 11-Sep-06 | | | | |
| DWG: 5498 | | | | |

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads
Dimensions in Inches/(mm)

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